

# Chapter 5 Electron Diffraction

- 5.1 Production of electron beams
- 5.2 Electron Diffraction
- 5.3 Indexing Electron Diffraction Patterns
- 5.4 Type of Electron Diffraction

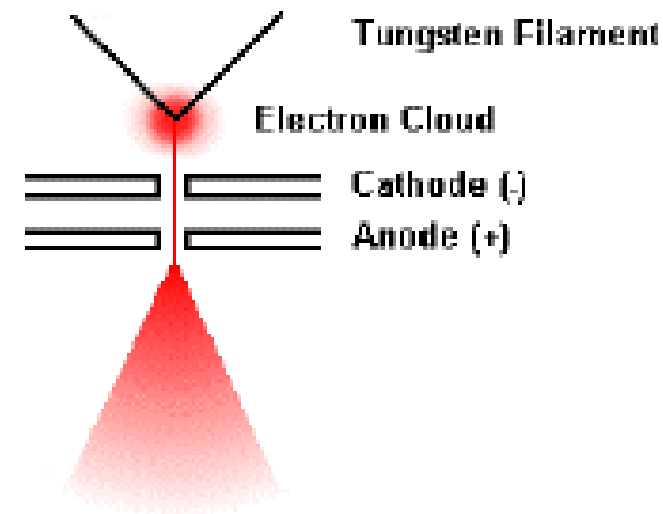
# Learning outcomes :

By the end of this topic, student will be able to do the following:

- Define and explain the duality properties of the electron.
- Identify and explain the production of electron.
- Define the electron scattering/diffraction.
- Write down the type of electron diffraction.
- Identify and draw the diagram of each electron diffraction method.
- Explain and show the basic working principle for each electron diffraction method.
- Identify the diffraction pattern for each method.
- Explain the electron diffraction pattern.
- Relate the pattern with the crystal system.
- Identify the crystal system using electron diffraction method.

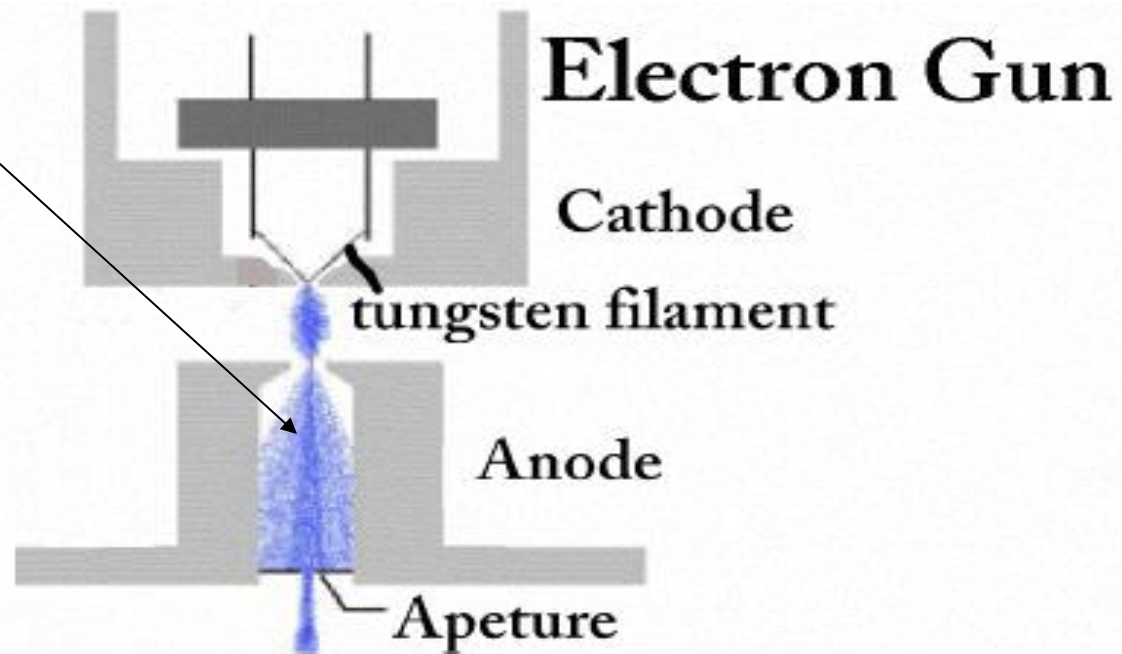
# 5.1 Production of electron beams

- An electron (beams) gun is used to produce a stream of electrons with a well defined kinetic energy for diffraction or other purposes.
- E-beams are mostly produced by ***thermionic emission*** from a heated cathode.
- An electron gun consist of two parts :
  - A heated filament,
  - The accelerating region, which is bounded by two electrodes, known as the cathode and the anode.



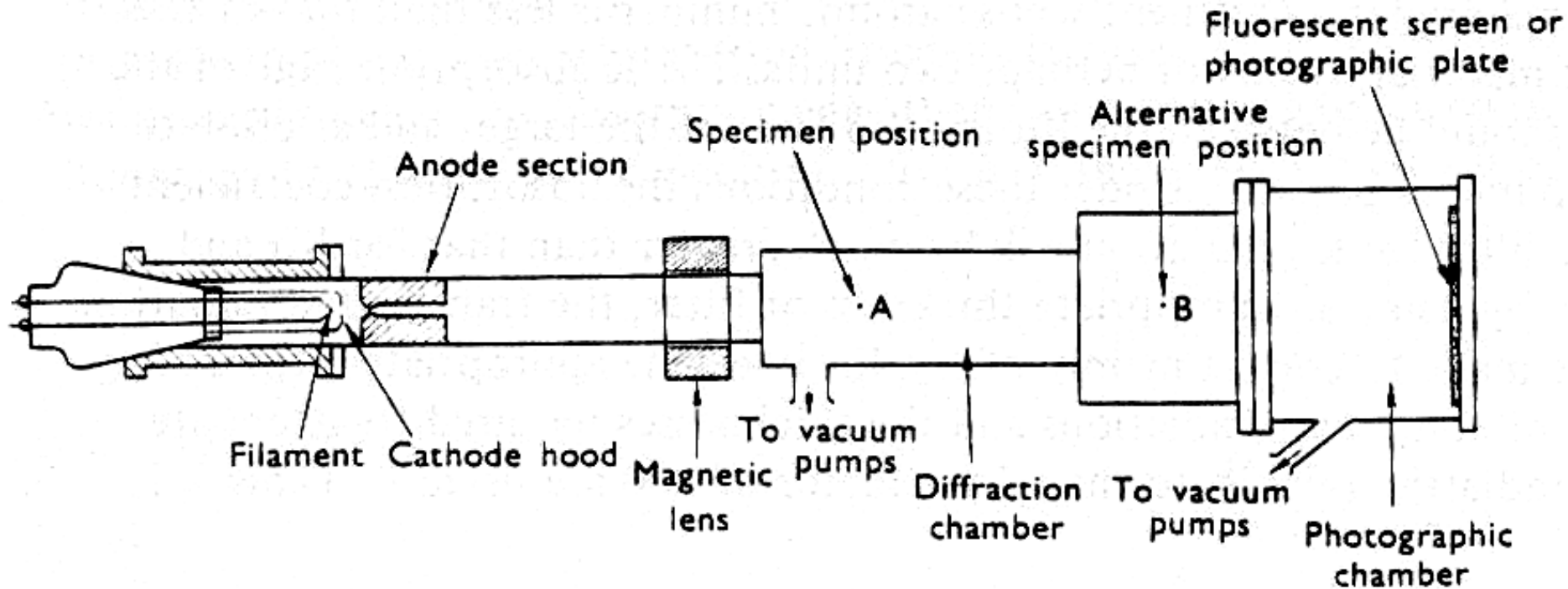
- The filament consists of a piece of wire, commonly made of a refractory material such as tungsten, which is heated by an electric current
- They drift through a small hole in the cathode, into a region where there is an electric field, which accelerates them across the gap to the anode.

They then pass through a hole in the anode, with a final energy which is determined by the applied voltage.



- ***Thermionic emission*** is a process by which some of the electrons inside a piece of metal can '*boil away*', that is leave the surface of the metal into the surrounding space.
- Inside a metal the electrons are not stationary, but are constantly moving, with an average speed which is controlled by the temperature of the metal.
- Since the speed of the electrons increases with temperature, the number of electrons with sufficient energy to escape also increases with temperature, in fact exponentially.
- At room temperature (300 K) the number is very small, but if the wire is heated to 1000K the number of electrons escaping is dramatically increased.

- The electron gun are very much the same as those of an electron microscope.
- In fact, many electron microscopes are designed so that they can also be used for obtained diffraction photographs.



- Electron with the energies used in diffraction are very strongly absorbed in matter.
- Specimen which are to be used in transmission must therefore be in the form of thin film (few hundreds Angstrom).
- Hence, if thicker specimens is used, only the surface layers of the specimen contribute to the diffraction pattern.
- The small penetration of low-energy electron into a crystal is exploited in the technique commonly know as **LEED** (low-energy electron diffraction).

# LEED

- This technique is used to study the structure of surface using electron in the energy range 10-500 eV.
- The penetration of such electrons into a solid is limited to between 3 to 10 Å (one to three atomic layer).
- The scattering depends very largely on the 2-D structure of the solid's surface.
- Electrons scattered in reflection from the surface of the sample are detected either by a Faraday collector or a fluorescent screen.



# LEED system

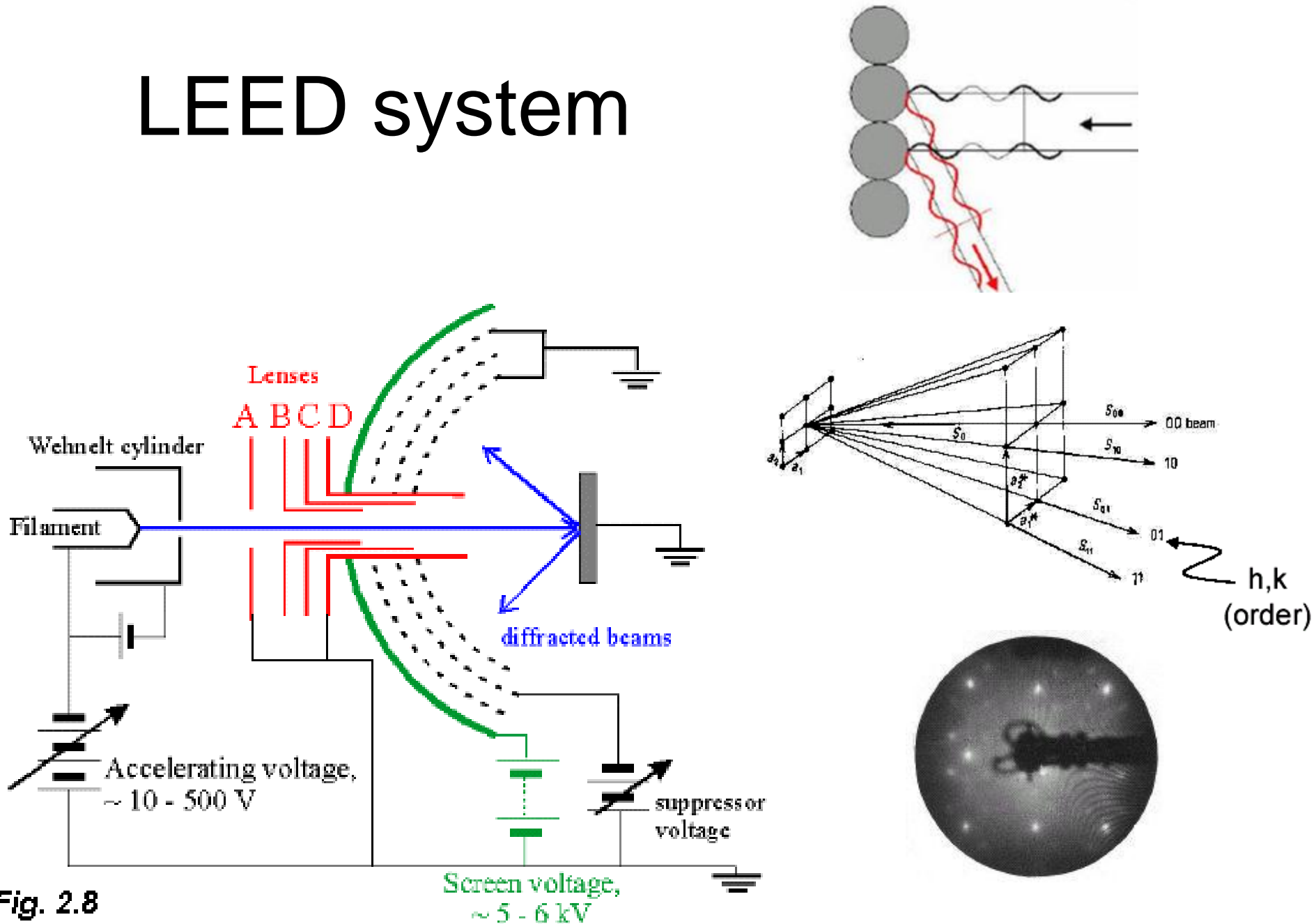


Fig. 2.8

## 5.2 Electron diffraction

- **Electron diffraction** is the phenomenon associated with interference that occur when electrons are scattered by atom to form diffraction patterns.
- The electrons are not only behavior as particles but as waves.
- Range of energy ( $E=eV$ ) :
  - Low energy (5 eV – 500 eV)
  - Medium energy (500 eV – 5 keV)
  - High energy ( 5 – 500 keV)

# Duality of electron

- In 1924, De Broglie claimed that *all* matter has a wave-like nature; he related wavelength,  $\lambda$ , and momentum,  $p$ :

$$\lambda = \frac{h}{p}$$

- He included the particle-wave property duality theory of matter, based on the work of Einstein ( $E=h\nu$ ) and Planck.
- De Broglie's formula was confirmed three years later by guiding a beam of electrons through a crystalline grid and observing the predicted interference patterns

- According to quantum theory, any particles moving with momentum  $mv$  has a wavelength

$$\lambda = \frac{h}{mv}$$

where  $h$  – Planck's constant.

- Therefore,  $v = \frac{p}{m}$

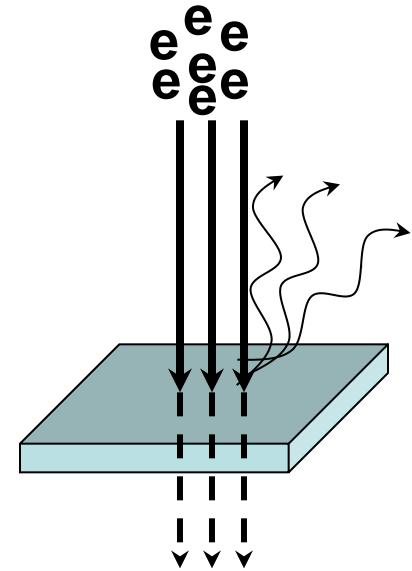
- Therefore, the kinetic energy is given by

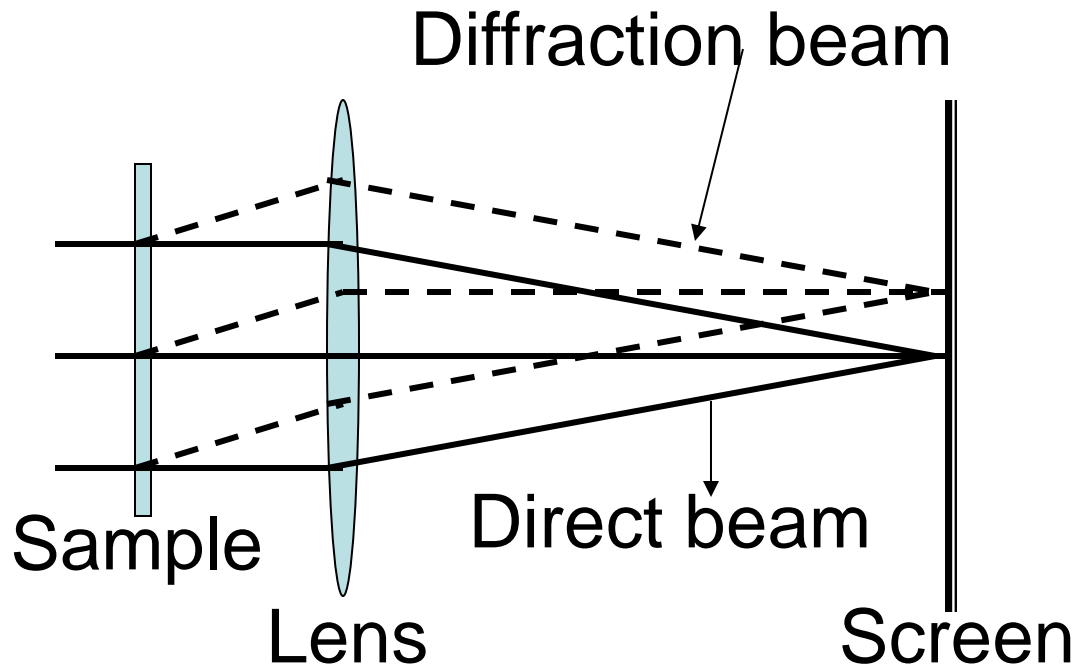
$$E = \frac{1}{2}mv^2 = \frac{p^2}{2m} = eV$$

- The technique is only used on crystal samples that have a regularly spaced atomic lattice.
- Electron diffraction has been used for phase identification, structure and symmetry determination, lattice parameter measurement.
- There are three types of electron diffraction:
  - Low Energy Electron Diffraction (LEED)
  - Transmission High Energy Electron Diffraction (THEED)
  - Reflection High Energy Electron Diffraction (RHEED).

- Most electron diffraction is performed with high energy electrons whose wavelengths are orders of magnitude smaller than the interplanar spacing in most crystals.
- For example, for 100 keV electrons  $\lambda < 3.7 \times 10^{-12}$  m. Typical lattice parameters for crystals are around 0.3 nm.
- Electrons are charged, light particles and their penetration into solids is very limited.
- They lose energy by inelastic scattering or are scattered elastically (diffraction).

- Therefore, both LEED and RHEED are considered to be surface characterization techniques.
- THEED is limited to specimens less than 1mm thick.
- THEED is usually carried out in a transmission electron microscope (TEM).





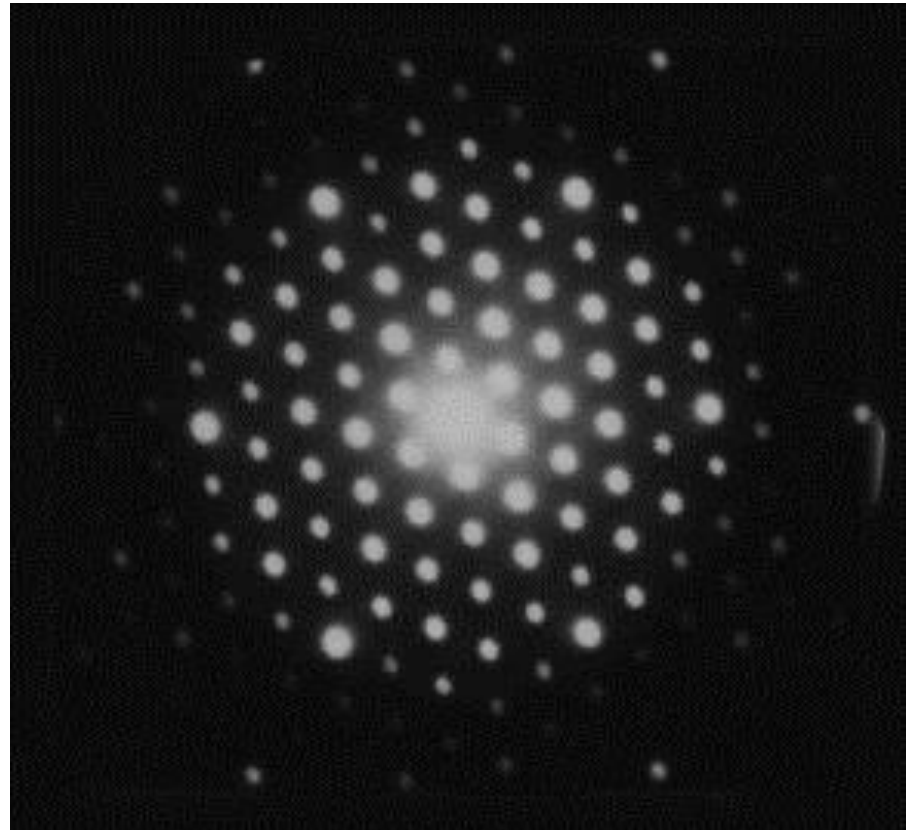
- Since  $\lambda$  is very small, Bragg angles are also small, so the Bragg Law can be simplified to:

$$\lambda = 2d\theta$$

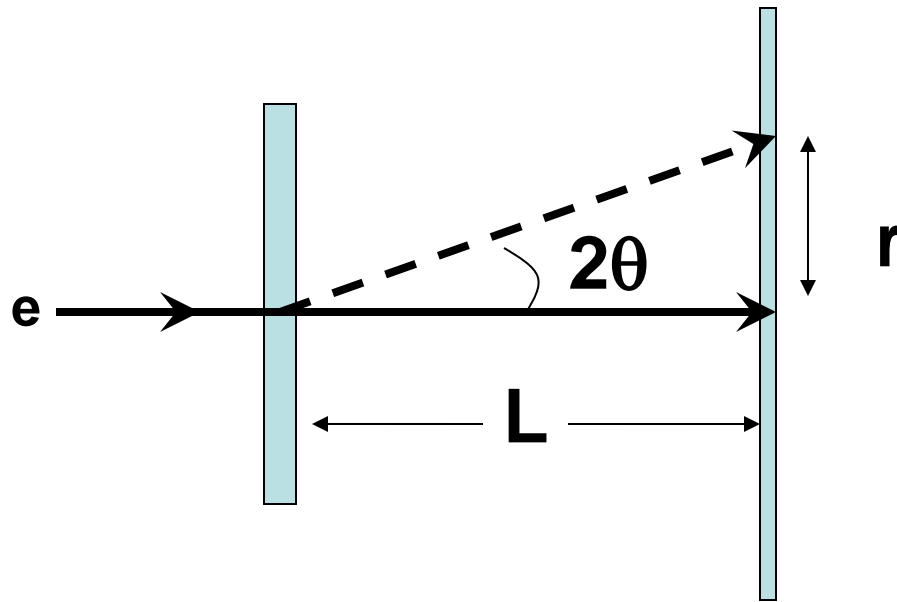
- The diameter of the Ewald sphere is very large compared to the size of the unit cell in the reciprocal lattice



- Lenses is used to focus the diffraction pattern and to change the camera length, which is equivalent to moving the film in an x-ray experiment.
- A typical electron diffraction pattern for a crystalline specimen is shown here.



# Geometry of an electron diffraction experiment



From the diagram :

$$\frac{r}{L} = 2\theta$$

Bragg Law for small angles approximates to:

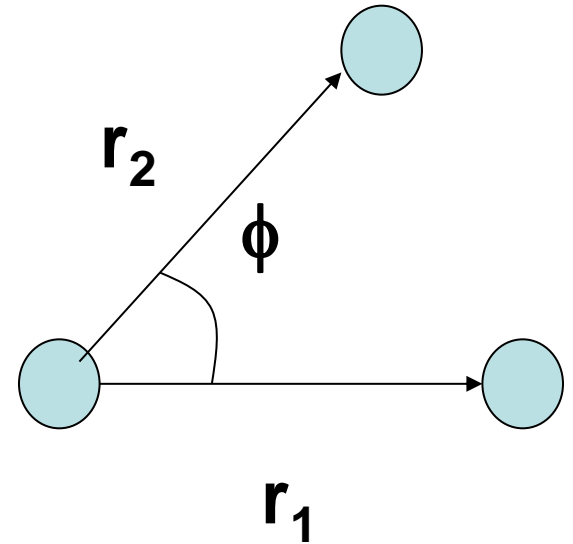
$$\lambda = 2d\theta$$

Therefore,  $\frac{r}{L} = \frac{\lambda}{d}$  or  $r = \lambda L \times \frac{1}{d}$

The distance,  $r$ , of a diffraction spot from the direct beam spot on the diffraction pattern, varies inversely with the spacing of the planes,  $d$ , that generate that spot.

## 5.3 Indexing Electron Diffraction pattern

- Choose one spot to be the origin
- Measure the spacing of 1<sup>st</sup> spot,  $r_1$  and 2<sup>nd</sup> spot,  $r_2$ .
- Measure the angle between the spots,  $\phi$ .
- Prepare a table giving the ratios of the spacings of permitted diffraction planes in the known structure



- Take the measured ratio  $r_1/r_2$  and locate a value close to this in the table.
- Assign the more widely-spaced plane (usually with lower indices) to the shorter  $r$  value.
- Calculate the angle between pair of planes of the type you have indexed.
- If the experimental angle,  $\phi$ , agrees with one of the possible values - accept the indexing. If not, revisit the table and select another possible pair of planes.
- Finish indexing the pattern by vector addition.

# Interplanar spacing tables

- From early studies, interplanar spacing,  $d$ , for a cubic structure with lattice parameter,  $a$ , is given by:

$$d = \frac{a}{\sqrt{h^2 + k^2 + l^2}}$$

- Therefore, the ratio of interplanar spacings between two different planes,  $d_1$  and  $d_2$  is:

$$\frac{d_1}{d_2} = \frac{\sqrt{h_1^2 + k_1^2 + l_1^2}}{\sqrt{h_2^2 + k_2^2 + l_2^2}}$$

# FCC

allowed reflections only from all even or all odd  $h,k,l$

|       |       | $d_1$ |       |       |       |       |       |
|-------|-------|-------|-------|-------|-------|-------|-------|
| $d_2$ | hkl   | {111} | {200} | {220} | {311} | {222} | {400} |
|       | {111} | 1     |       |       |       |       | 2.31  |
|       | {200} | 1.5   | 1     |       |       |       |       |
|       | {220} | 0.61  | 0.71  | 1     |       |       |       |
|       | {311} | 0.52  |       |       | 1     |       |       |
|       | {222} |       |       |       |       | 1     |       |
|       | {400} |       |       |       |       |       | 1     |

# BCC

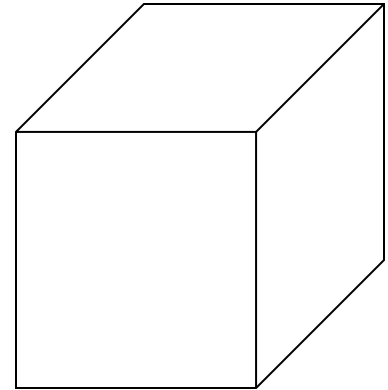
allowed reflections only from  $h+k+l = \text{even}$

|       |       | $d_1$ |       |       |       |       |       |
|-------|-------|-------|-------|-------|-------|-------|-------|
|       | hkl   | {110} | {200} | {211} | {220} | {310} | {222} |
| $d_2$ | {110} | 1     |       |       |       |       |       |
|       | {200} |       | 1     |       |       | 1.58  |       |
|       | {211} |       | 0.82  | 1     |       |       |       |
|       | {220} |       |       |       | 1     |       |       |
|       | {310} |       |       |       |       | 1     |       |
|       | {222} |       |       |       |       |       | 1     |

# Calculating the angle between two planes

- For cubic crystals, the angle,  $\phi$  between two planes,  $(h_1 \ k_1 \ l_1)$  and  $(h_2 \ k_2 \ l_2)$  is given by:

$$\cos \phi = \frac{h_1 h_2 + k_1 k_2 + l_1 l_2}{\sqrt{h_1^2 + k_1^2 + l_1^2} \sqrt{h_2^2 + k_2^2 + l_2^2}}$$





## Example:

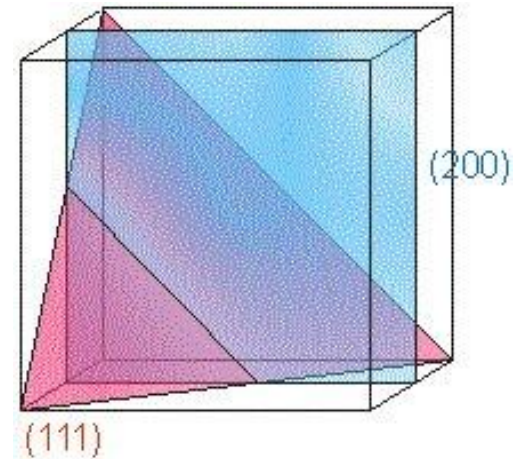
Calculate the angle between the (111) and (200) planes.

From equation above,

$$\cos \phi = \frac{(1 \times 2) + (1 \times 0) + (1 \times 0)}{\sqrt{1+1+1} \cdot \sqrt{4+0+0}}$$

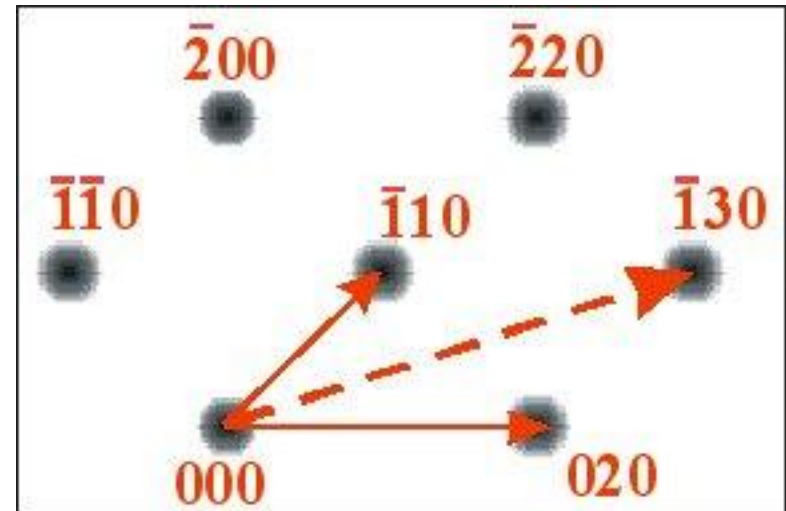
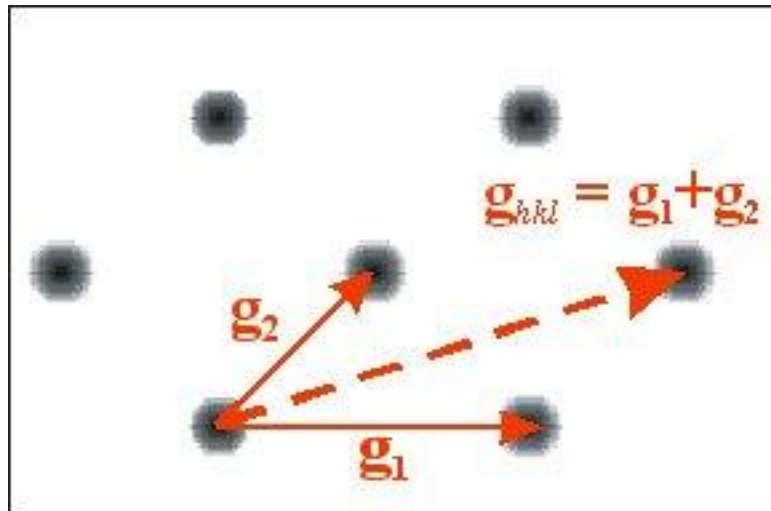
$$\cos \phi = \frac{1}{\sqrt{3}}$$

Therefore,  $\phi = 54.75$



# Indexing Electron Diffraction Patterns

- If we know the index for two diffraction spots it is possible to index the rest of the spots by using vector addition.
- Every diffraction spot can be reached by a combination of these two vectors.



# Why XRD is difficult to applied to surface ?

- X-ray photons have micron-scale penetration depths into solids which means that X-ray diffraction is not an inherently surface-sensitive technique.
- Low energy electrons, however, have penetration depths (mean free paths) of the order of a few lattice spacings of the solid and are therefore more suited to surface diffraction.

## 5.4 Type of Electron Diffraction

- Electron diffraction is frequently used to study the crystal structure of solids.
- Experiments are usually performed in a transmission electron microscope (TEM), or a scanning electron microscope (SEM) as electron backscatter diffraction.
- The periodic structure of a crystalline solid acts as a diffraction grating, scattering the electrons in a predictable manner.
- Sometime, electron diffraction is incorporate in other system to determine in-situ crystal structure.
- Two common type of electron diffraction:
  - Low energy electron diffraction
  - Reflection High Energy Electron Diffraction

# Low energy electron diffraction : 1

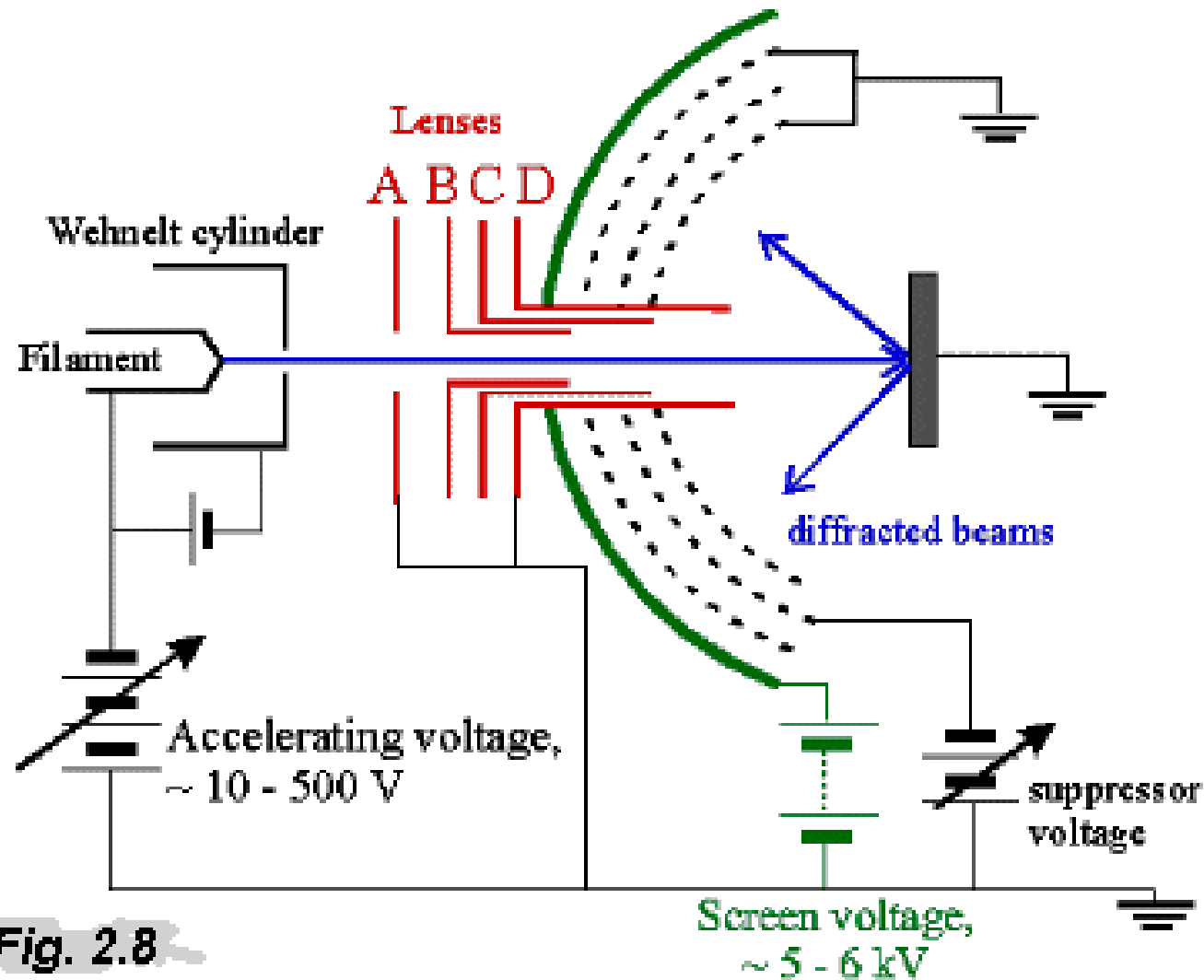


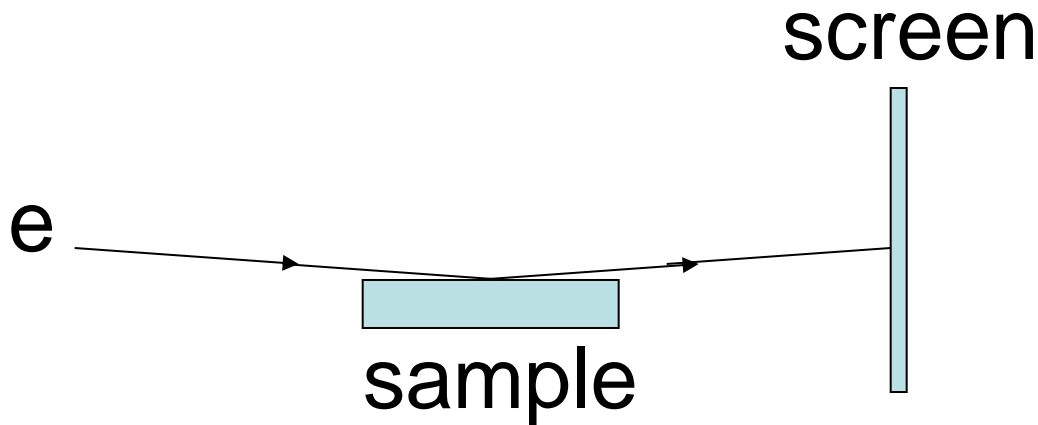
Fig. 2.8

- Electrons are thermionically emitted by the heated filament.
- The energy with which the electrons are incident on the sample is determined by the acceleration voltage (i.e. the voltage between the filament and apertures A and D).
- Apertures B and C are used to focus the electron beam.
- The incident electrons are backscattered from the sample surface and strike the fluorescent screen to create the diffraction pattern.
- The screen is at a high positive potential with respect to the sample surface so that the low energy, elastically scattered electrons are accelerated onto the screen.

- If the electrons is accelerated through a potential of 30 to 500 volts (i.e., their kinetic energy is around 30 to 500 eV), their wavelength is  $2.2\text{\AA}$  to  $0.5\text{\AA}$ .
- This fits nicely into the range of distances between atoms in solids and can therefore strongly diffract from them.
- The recording and analysis of the diffraction pattern can tell us the arrangement of the atoms on the surface.

# Reflection High Energy Electron Diffraction

- RHEED performed at glancing angles of reflection using electrons in the 10 - 100KeV range.



- The sample can be rotated about its normal axis so that the electron beam is incident along specific crystallographic directions on the surface



# **What advantages does RHEED offer over LEED ?**

- The geometry of the experiment allows much better access to the sample during observation of the diffraction pattern.
- This is particularly important if it is desired to make observations of the surface structure during growth of a surface film by evaporation from sources located normal to the sample surface.

- Experiments have shown that it is possible to monitor the atomic layer-by-atomic layer growth of epitaxial films by monitoring oscillations in the intensity of the diffracted beams in the RHEED pattern.
- By using RHEED it is therefore possible to measure, and hence also to control, atomic layer growth rates in Molecular Beam Epitaxy (MBE) growth of electronic device structures.